

DATA SHEET

74AC574/74ACT574

Octal D-type flip-flop; positive
edge-trigger (3-State)

Product specification

1997 Apr 08

Octal D-type flip-flop; positive edge-trigger (3-State)

74AC574
74ACT574

FEATURES

- 74ACT574 has TTL-compatible inputs
- 74AC574 has CMOS-compatible inputs
- 3-State outputs source/sink 24mA
- 3-State outputs drive bus lines or buffer memory address registers
- Buffered positive edge-triggered clock
- Meets or exceeds JEDEC standard for 74AC(T)XX family
- Superior ground bounce noise immunity

DESCRIPTION

The 74AC574/74ACT574 is an octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-State outputs for bus-oriented applications. A clock (CP) and an output enable (\overline{OE}) input are common to all flip-flops.

The eight flip-flops will store the state of their individual D-inputs that meet the setup and hold times requirements on the LOW-to-HIGH CP transition.

When \overline{OE} is LOW, the contents of the eight flip-flops is available at the outputs. When \overline{OE} is HIGH, the outputs go to the high impedance OFF-state. Operation of the \overline{OE} input does not affect the state of the flip-flops.

The '574' is functionally identical to the '374', but the '374' has a different pin arrangement.

QUICK REFERENCE DATA

GND = 0V; $T_{amb} = 25^{\circ}\text{C}$; $t_r = t_f \leq 2.5 \text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL			UNIT
			AC		ACT	
			$V_{CC} = 3.3\text{V}$	$V_{CC} = 5.0\text{V}$	$V_{CC} = 5.0\text{V}$	
t_{PHL}/t_{PLH}	Propagation delay An to Bn; Bn to An	$C_L = 50\text{pF}$	5.5	3.8	4.9	ns
f_{max}	Maximum clock frequency	$C_L = 50\text{pF}$	120	180	160	MHz
C_I	Input capacitance		4.5			pF
C_{PD}	Power dissipation capacitance	$V_I = \text{GND to } V_{CC}^1$ outputs enabled ²	26		29	pF
		outputs enabled ³	91		93	
		outputs disabled ²	15		19	
		outputs disabled ³	44		36	

NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz; C_L = output load capacity in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.
2. Switch the clock and one data input such that one flip-flop toggles
3. Switch the clock and all data inputs such that all flip-flops toggle

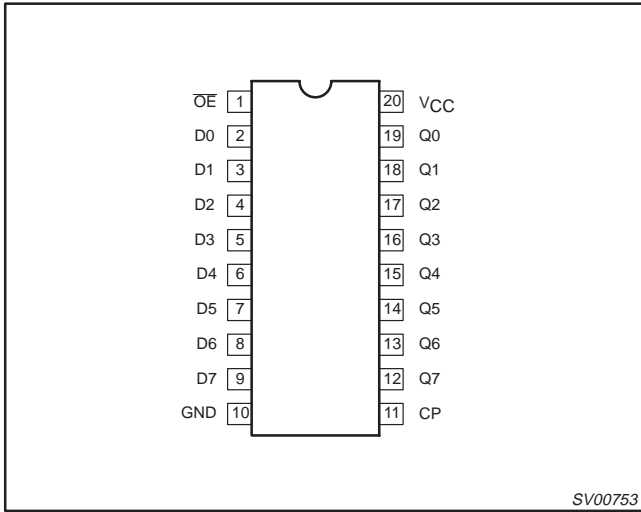
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
20-Pin Plastic SO	-40°C to $+85^{\circ}\text{C}$	74AC574 D 74ACT574 D	74AC574 D 74ACT574 D	SOT163-1
20-Pin Plastic SSOP Type II	-40°C to $+85^{\circ}\text{C}$	74AC574 DB 74ACT574 DB	74AC574 DB 74ACT574 DB	SOT339-1
20-Pin Plastic TSSOP Type I	-40°C to $+85^{\circ}\text{C}$	74AC574 PW 74ACT574 PW	74AC574 PW DH 74ACT574 PW DH	SOT360-1

Octal D-type flip-flop; positive edge-trigger (3-State)

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PIN CONFIGURATION

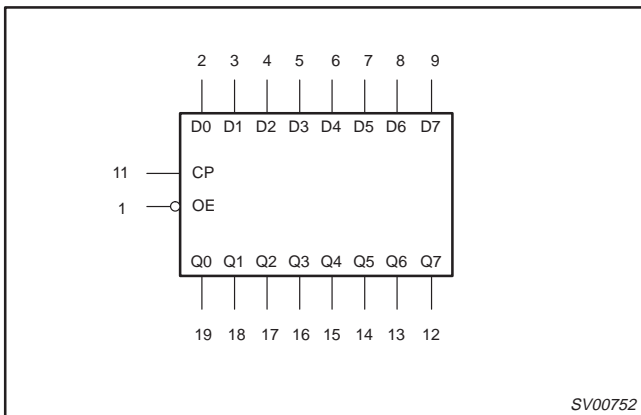


SV00753

PIN DESCRIPTION

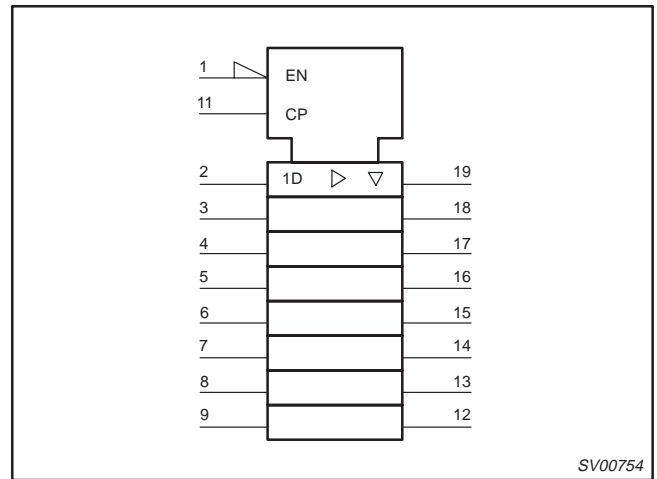
PIN NUMBER	SYMBOL	FUNCTION
1	\overline{OE}	Output enable input (active-Low)
2, 3, 4, 5, 6, 7, 8, 9	D0-D7	Data inputs
19, 18, 17, 16, 15, 14, 13, 12	Q0-Q7	Data outputs
11	CP	Clock pulse input (active rising edge)
10	GND	Ground (0V)
20	V _{CC}	Positive supply voltage

LOGIC SYMBOL



SV00752

LOGIC SYMBOL (IEEE/IEC)



SV00754

Octal D-type flip-flop; positive edge-trigger (3-State)

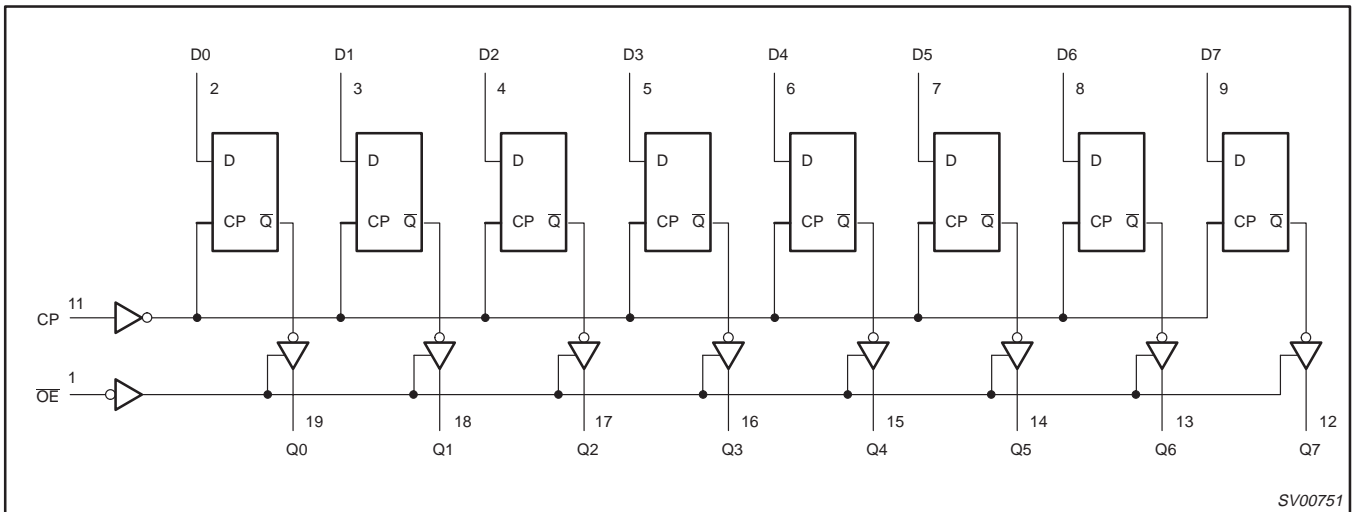
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FUNCTION TABLE

OPERATING MODES	INPUTS			INTERNAL FLIP-FLOPS	OUTPUTS
	OE	CP	D _n		Q ₀ to Q ₇
Load and read register	L L	↑	l h	L H	L H
Load register and disable outputs	H H	↑	l h	L H	Z Z

H = HIGH voltage level
 h = HIGH voltage level one setup time prior to the LOW-to-HIGH CP transition
 L = LOW voltage level
 l = LOW voltage level one setup time prior to the LOW-to-HIGH CP transition
 Z = High impedance OFF-state
 ↑ = LOW-to-HIGH clock transition

LOGIC DIAGRAM



SV00751

Octal D-type flip-flop; positive edge-trigger (3-State)

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN	MAX	
V_{CC}	DC supply voltage for 'AC	2.0	6.0	V
V_{CC}	DC supply voltage for 'ACT	4.5	5.5	V
V_{IN}	DC input voltage range	0	V_{CC}	V
V_O	DC output voltage range	0	V_{CC}	V
T_{amb}	Operating free-air temperature range	-40	+85	°C
$\Delta V/\Delta t$	Minimum input edge rate — AC devices V_{IN} from 30% to 70% of V_{CC} V_{CC} @ 3.3V, 4.5V, 5.5V	125		mV/ns
	— ACT devices V_{IN} from 0.8V to 2.0V V_{CC} @ 4.5V, 5.5V	125		

ABSOLUTE MAXIMUM RATINGS¹

in accordance with the Absolute Maximum Rating System (IEC134)
Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		-0.5 to +7.0	V
I_{IK}	DC input diode current	$V_{IN} = -0.5V$	-20	mA
		$V_{IN} = V_{CC} + 0.5V$	+20	
V_{IN}	DC input voltage		-0.5 to $V_{CC} + 0.5$	V
I_{OK}	DC output diode current	$V_O = -0.5V$	-20	mA
		$V_O = V_{CC} + 0.5V$	+20	
V_O	DC output voltage		-0.5 to $V_{CC} + 0.5$	V
I_O	DC output source or sink current		± 50	mA
I_{CC}, I_{GND}	DC V_{CC} or GND current per output		± 50	mA
I_{CC}, I_{GND}	DC V_{CC} or GND current		± 200	mA
T_{stg}	Storage temperature range		-65 to 150	°C
P_{TOT}	Power dissipation per package — plastic mini-pack (SO) — plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K	500	mW
		above +60°C derate linearly with 5.5 mW/K	500	

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Octal D-type flip-flop; positive edge-trigger (3-State)

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74ACT574**DC ELECTRICAL CHARACTERISTICS (74AC574)**

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	TEST CONDITIONS	V _{CC} (V)	LIMITS			UNIT	
				Temp = -40°C to +85°C				
				MIN	TYP ¹	MAX		
V _{IH}	HIGH level Input voltage	V _{OUT} = 0.1V or (V _{CC} - 0.1V)	3.0	2.1	1.5		V	
			4.5	3.15	2.25			
			5.5	3.85	2.75			
V _{IL}	LOW level Input voltage	V _{OUT} = 0.1V or (V _{CC} - 0.1V)	3.0		1.5	0.9	V	
			4.5		2.25	1.35		
			5.5		2.75	1.65		
V _{OH}	HIGH level output voltage	I _{OUT} = -50 μA	3.0	2.9	2.99		V	
			4.5	4.4	4.49			
			5.5	5.4	5.49			
			V _{IN} = V _{IL} or V _{IH} , I _{OH} = -12mA ¹	3.0	2.46			V
			V _{IN} = V _{IL} or V _{IH} , I _{OH} = -24mA ¹	4.5	3.76			
			V _{IN} = V _{IL} or V _{IH} , I _{OH} = -24mA ¹	5.5	4.76			
V _{OL}	LOW level output voltage	I _{OUT} = 50 μA	3.0		0.01	0.1	V	
			4.5		0.01	0.1		
			5.5		0.01	0.1		
			V _{IN} = V _{IL} or V _{IH} , I _{OL} = 12mA ¹	3.0			0.44	V
			V _{IN} = V _{IL} or V _{IH} , I _{OL} = 24mA ¹	4.5			0.44	
			V _{IN} = V _{IL} or V _{IH} , I _{OL} = 24mA ¹	5.5			0.44	
I _{IN}	Input leakage current	V _{IN} = V _{CC} , GND	5.5			±1.0	μA	
I _{OZ}	3-State output OFF-state current	V _{IN} (OE) = V _{IL} , V _{IH} V _{IN} = V _{CC} , GND V _{OUT} = V _{CC} , GND	5.5			±2.5	μA	
I _{OLD} ²	Dynamic output current ²	V _{OLD} = 1.65V max	5.5	75			mA	
I _{OHD} ²	Dynamic output current ²	V _{OHD} = 3.85V min	5.5			-75	mA	
I _{CC}	Quiescent supply current	V _{IN} = V _{CC} or GND	5.5			40	μA	

NOTES:

1. All outputs loaded
2. Maximum test duration 2.0 ms; one output loaded at a time

Octal D-type flip-flop; positive edge-trigger (3-State)

74AC574
74ACT574**DC ELECTRICAL CHARACTERISTICS (74ACT574)**

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	TEST CONDITIONS	V _{CC} (V)	LIMITS			UNIT
				Temp = -40°C to +85°C			
				MIN	TYP ¹	MAX	
V _{IH}	HIGH level Input voltage	V _{OUT} = 0.1V or (V _{CC} - 0.1V)	4.5	2.0	1.5		V
			5.5	2.0	1.5		
V _{IL}	LOW level Input voltage	V _{OUT} = 0.1V or (V _{CC} - 0.1V)	4.5		1.5	0.8	V
			5.5		1.5	0.8	
V _{OH}	HIGH level output voltage	I _{OUT} = -50 μA	4.5	4.4	4.49		V
			5.5	5.4	5.49		
		V _{IN} = V _{IL} or V _{IH} , I _{OH} = -24mA ¹	4.5	3.76	3.86		V
			5.5	4.76	4.86		
V _{OL}	LOW level output voltage	I _{OUT} = 50 μA	4.5		0.01	0.1	V
			5.5		0.01	0.1	
		V _{IN} = V _{IL} or V _{IH} , I _{OL} = 24mA ¹	4.5			0.44	V
			5.5			0.44	
I _{IN}	Input leakage current	V _{IN} = V _{CC} , GND	5.5			±1.0	μA
I _{OZ}	3-State output OFF-state current	V _{IN} (OE) = V _{IL} , V _{IH} V _{IN} = V _{CC} , GND V _{OUT} = V _{CC} , GND	5.5			±2.5	μA
ΔI _{CC}	Additional quiescent supply current per input pin	V _{IN} = V _{CC} - 2.1V Other inputs at V _{CC} or GND; I _{OUT} = 0	5.5			1.5	mA
I _{OLD} ²	Dynamic output current	V _{OLD} = 1.65V max	5.5	75			mA
I _{OHD} ²	Dynamic output current	V _{OHD} = 3.85V min	5.5			-75	mA
I _{CC}	Quiescent supply current	V _{IN} = V _{CC} or GND	5.5			40	μA

NOTES:

1. All outputs loaded
2. Maximum test duration 2.0ms, one output loaded at a time

Octal D-type flip-flop; positive edge-trigger (3-State)

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74ACT574**AC CHARACTERISTICS FOR 74AC574**GND = 0V; $t_R = t_F = 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 500\Omega$; .

SYMBOL	PARAMETER	V_{CC}^1 (V)	LIMITS					UNIT	WAVEFORM
			$T_{amb} = +25^\circ\text{C}$			$T_{amb} = -40^\circ\text{C to } +85^\circ\text{C}$			
			MIN	TYP	MAX	MIN	MAX		
t_{PLH}	Propagation delay CP to Q_n	3.3 5.0	2.0 1.5	5.5 3.8	11.5 8.5	1.5 1.0	13.5 9.5	ns	1
t_{PHL}	Propagation delay CP to Q_n	3.3 5.0	2.0 1.5	5.5 3.8	11.5 8.5	1.5 1.0	13.5 9.5	ns	1
t_{PZH}	3-State output enable time \overline{OE} to Q_n	3.3 5.0	2.0 1.5	4.9 3.5	10.0 8.0	1.5 1.0	11.5 9.0	ns	3
t_{PZL}	3-State output enable time OE to Q_n	3.3 5.0	2.0 1.5	5.8 4.2	10.0 8.0	1.5 1.0	11.5 9.0	ns	3
t_{PHZ}	3-State output disable time \overline{OE} to Q_n	3.3 5.0	2.0 1.5	4.8 3.0	9.0 7.5	1.5 1.0	10.0 8.5	ns	3
t_{PLZ}	3-State output disable time OE to Q_n	3.3 5.0	2.0 1.5	4.3 2.8	9.0 7.5	1.5 1.0	10.0 8.5	ns	3
t_w	CP pulse width HIGH or LOW	3.3 5.0	6.0 4.0	2.4 2.2		7.0 5.0		ns	1
t_{su}	Set up time D_n to CP	3.3 5.0	2.5 1.5	0.1 0.1		3.0 2.0		ns	2
t_h	Hold time D_n to CP	3.3 5.0	1.5 1.5	0.0 0.0		1.5 1.5		ns	2
f_{max}	Maximum clock pulse frequency	3.3 5.0	75 110	120 180		60 100		MHz	

NOTE:

1. Voltage range 3.3V is $V_{CC} = 3.3V \pm 0.3V$
Voltage range 5.0V is $V_{CC} = 5.0V \pm 0.5V$

AC CHARACTERISTICS FOR 74ACT574¹GND = 0V; $t_R = t_F = 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 500\Omega$; .

SYMBOL	PARAMETER	V_{CC}^1 (V)	LIMITS					UNIT	WAVEFORM
			$T_{amb} = +25^\circ\text{C}$			$T_{amb} = -40^\circ\text{C to } +85^\circ\text{C}$			
			MIN	TYP	MAX	MIN	MAX		
t_{PLH}	Propagation delay CP to Q_n	5.0	2.0	5.0	9.5	1.5	11.0	ns	1
t_{PHL}	Propagation delay CP to Q_n	5.0	2.0	4.8	9.5	1.5	11.0	ns	1
t_{PZH}	3-State output enable time \overline{OE} to Q_n	5.0	2.0	5.2	9.0	1.5	10.0	ns	3
t_{PZL}	3-State output enable time OE to Q_n	5.0	2.0	5.2	9.0	1.5	10.0	ns	3
t_{PHZ}	3-State output disable time \overline{OE} to Q_n	5.0	2.0	4.3	8.0	1.5	9.0	ns	3
t_{PLZ}	3-State output disable time OE to Q_n	5.0	2.0	4.3	8.0	1.5	9.0	ns	3
t_w	CP pulse width HIGH or LOW	5.0	3.0	2.6		4.0		ns	1
t_{su}	Set up time D_n to CP	5.0	2.0	0.1		2.5		ns	2
t_h	Hold time D_n to CP	5.0	1.0	0.0		1.0		ns	2
f_{max}	Maximum clock pulse frequency	5.0	100	160		90		MHz	

NOTE:

1. These values are at $V_{CC} = 5.0V \pm 0.5V$

Octal D-type flip-flop; positive edge-trigger (3-State)

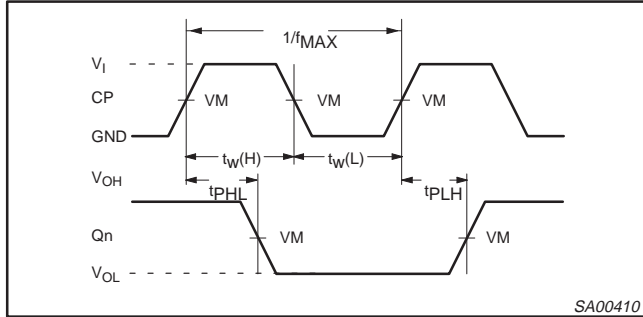
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AC WAVEFORMS

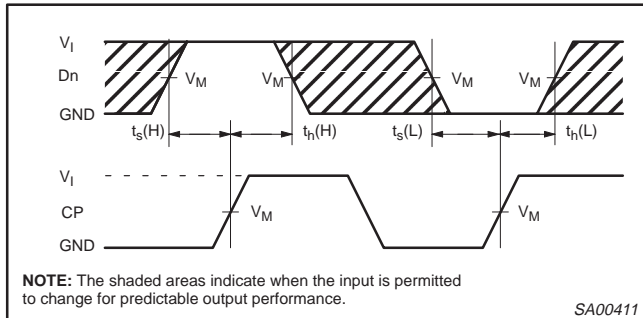
V_{OL} and V_{OH} are the typical output voltage drops that occur with the output load.

$$V_X = V_{OL} + 0.3V$$

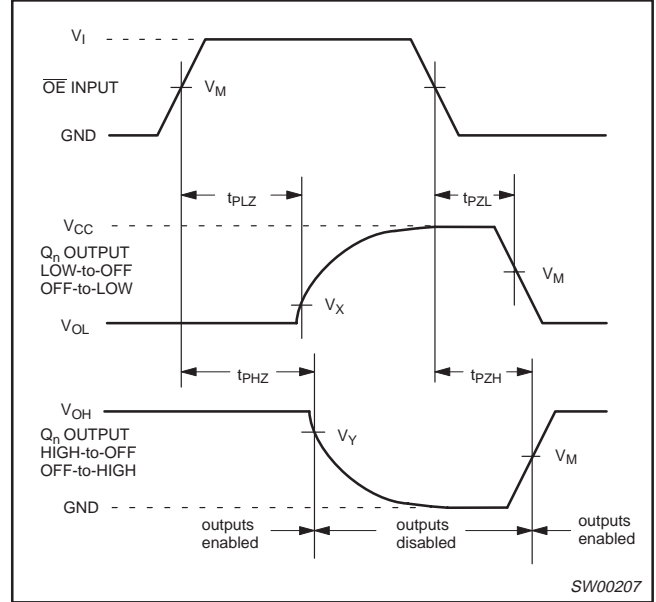
$$V_Y = V_{OH} - 0.3V$$



Waveform 1. Propagation delay, clock input to output, clock pulse width, and maximum clock frequency



Waveform 2. Data setup and hold times

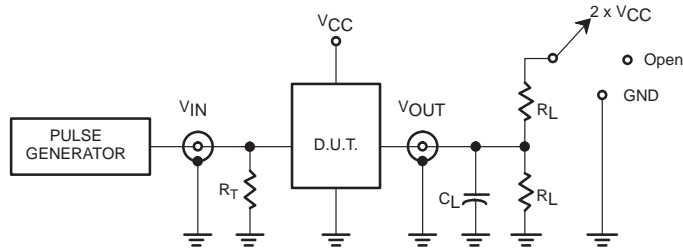


Waveform 3. Waveforms showing the 3-State output enable and disable times.

Octal D-type flip-flop; positive edge-trigger (3-State)

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TEST CIRCUIT AND WAVEFORM



Test Circuit for 3-State Outputs

SWITCH POSITION

TEST	SWITCH
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	Open

FAMILY	V_I Input Requirements	V_m Input	V_m Output
AC	GND to V_{CC}	50% V_{CC}	50% V_{CC}
ACT	GND to 3.0V	1.5V	50% V_{CC}

DEFINITIONS

- R_L = Load resistor; see AC CHARACTERISTICS for value.
- C_L = Load capacitance, see AC characteristics
- R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

SV00451

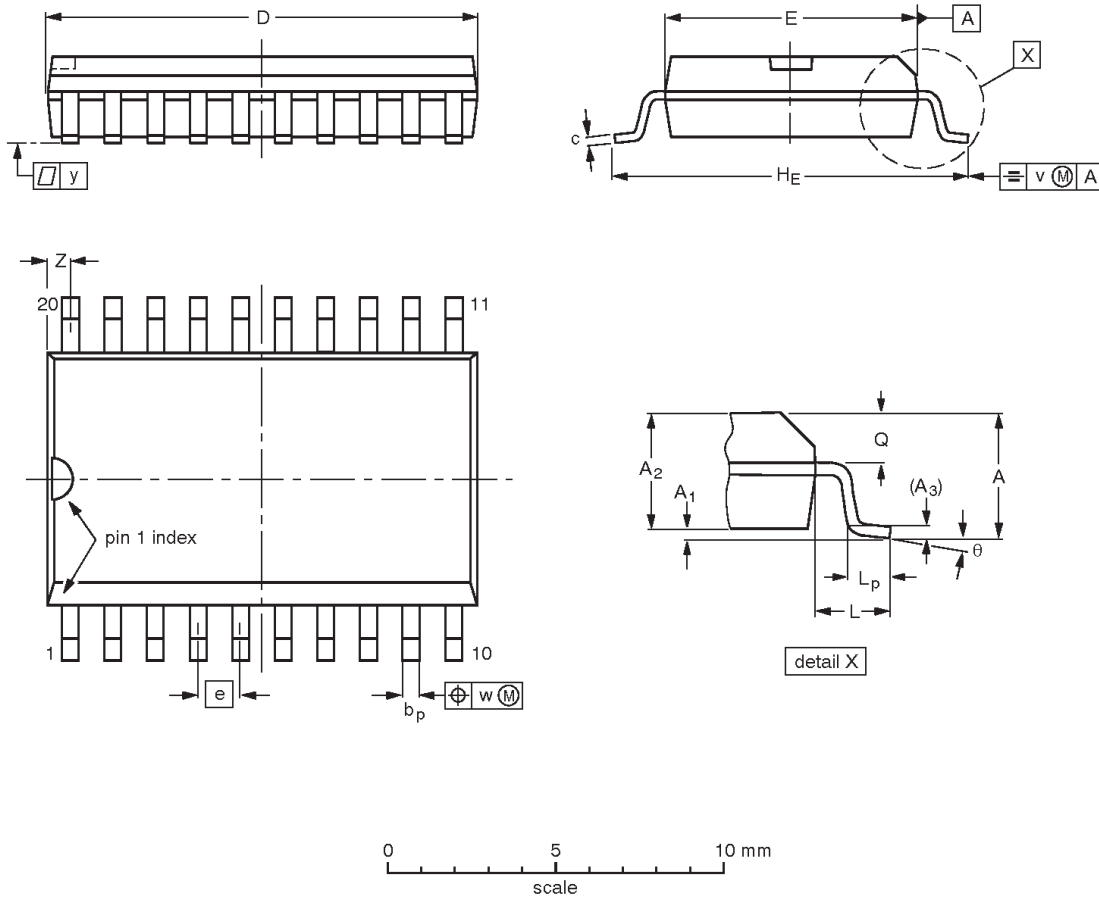
Waveform 4. Load circuitry for switching times.

Octal D-type flip-flop; positive edge-trigger (3-State)

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SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

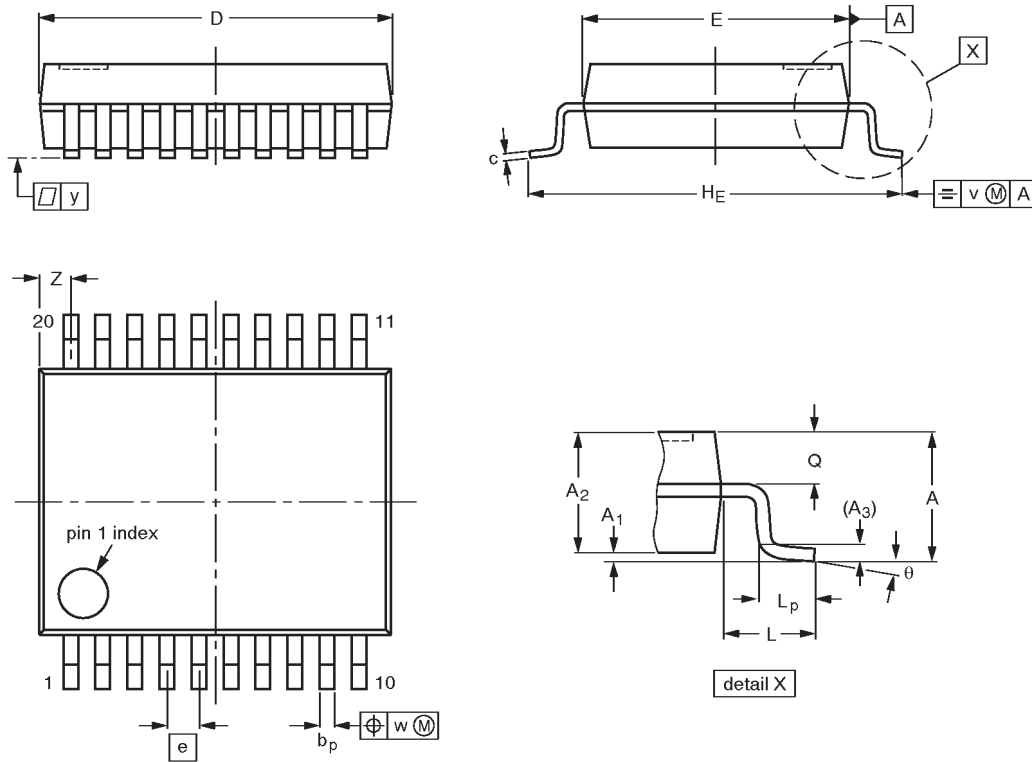
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT163-1	075E04	MS-013AC				92-11-17 95-01-24

Octal D-type flip-flop; positive edge-trigger (3-State)

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

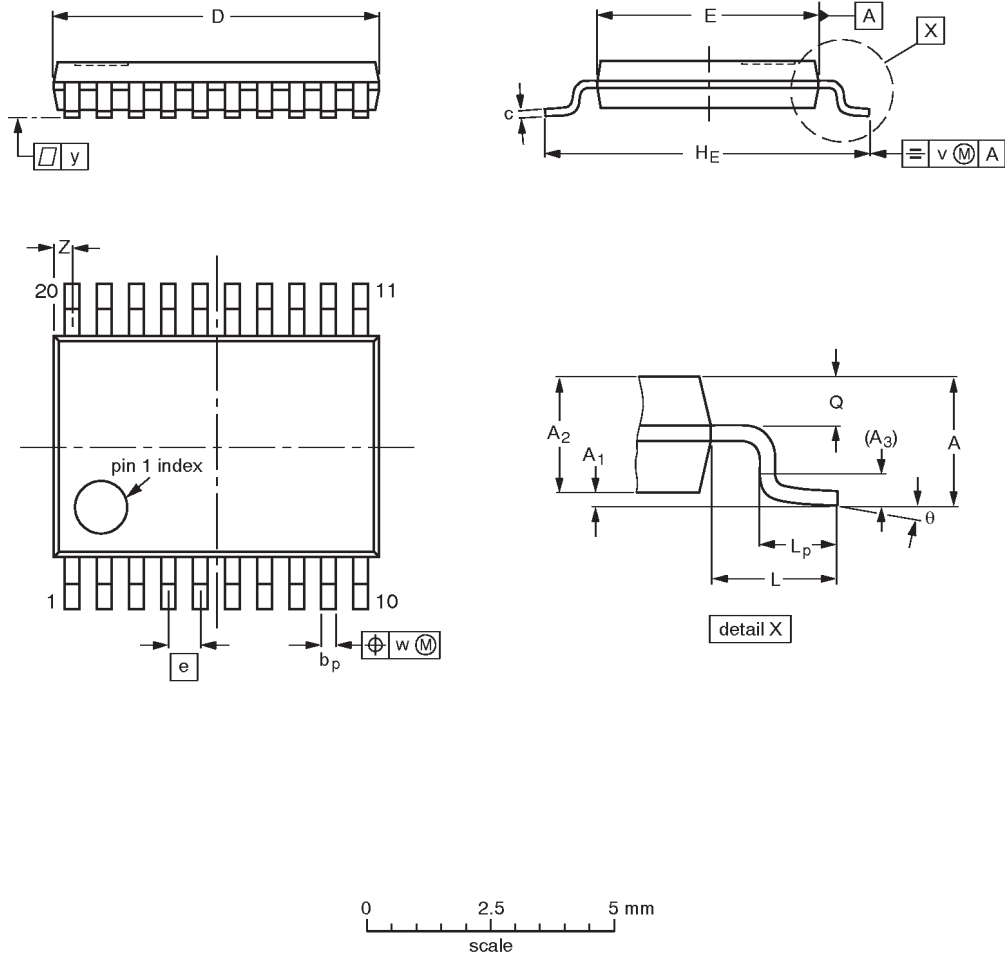
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT339-1		MO-150AE				93-09-08 95-02-04

Octal D-type flip-flop; positive edge-trigger (3-State)

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT360-1		MO-153AC				-93-06-16- 95-02-04

Octal D-type flip-flop; positive edge-trigger (3-State)

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DEFINITIONS

Data Sheet Identification	Product Status	Definition
<i>Objective Specification</i>	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
<i>Preliminary Specification</i>	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
<i>Product Specification</i>	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.

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